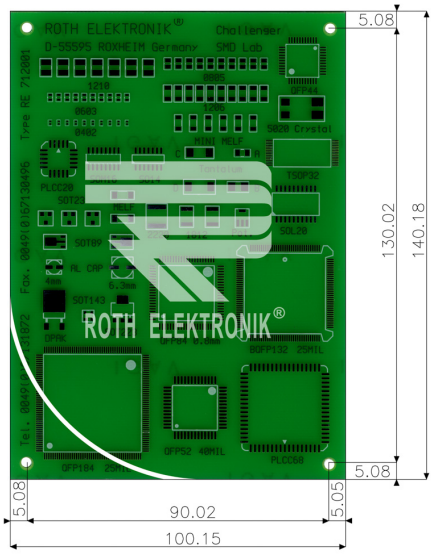

RE712001-LF

- Epoxy fibre-glass FR4 1.50 mm
- Single-sided 35 µm CU
- Without holes
- Hot air leveling (HAL-leadfree) with solder stop mask
- Component print
- PCB for 85 solder practices for SMD standard, fine pitch, and discrete components:

version	**quantity**
PLCC	52, 68, 20
QFP	44, 84, 132, 184 sq.
SOT23	3 x
SOT89	2 x
SOT143	1 x
SOT233	1 x
SO14	1 x
SOM16	1 x
SOL20	1 x
Poti.	1 x
DPAK	1 x
Al. Kond. 6.30 mm	1 x
Al. Kond. 4.00 mm	1 x
Melf 2308	2 x
Mini Melf 1206	6 x
Tantal Chip Kond. A	1
Tantal Chip Kond. B	1
Tantal Chip Kond. C	1
Tantal Chip Kond. D	1
0402 Chip Kond.	10 x
0603 Chip Kond.	10 x
1206 Chip Kond.	10 x
0805 Chip Kond.	10 x
1210 Chip Kond.	7 x
2220 Chip Kond.	1 x
1812 Chip Kond	2 x
TSOP32	1 x
5020 Schwingquarz	1 x

- Also very suitable for machine assembly (Pick and Place)
- Size 100 x 140 mm

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